

# Cree<sup>®</sup> XLamp<sup>®</sup> XB-D LEDs





The XLamp XB-D is Cree's newest lighting class LED, bringing the next generation of performance and price to LED lighting applications. The XLamp XB-D delivers similar performance to the XP-G LED in a package that is 48% smaller than the XLamp XP footprint.

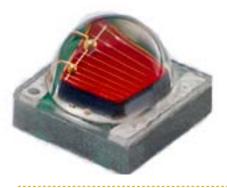
Using Cree's newest generation of silicon carbide-based LED chips, XB-D is optimized to dramatically lower system cost in any illumination application.



#### **FEATURES**

- Cree's smallest lighting class
   LED: 2.45 X 2.45 mm
- Up to 136 lm/W in cool white (@ 85 °C, 350 mA)
- Available in white, 80-minimum CRI white, and 70-minimum CRI cool white, royal blue, blue, green, amber, red-orange
   8 red
- 1 A maximum drive current
- Low thermal resistance:6.5 °C/W
- Wide viewing angle: 115°
- Reflow solderable JEDEC
   J-STD-020C compatible
- Unlimited floor life at
   ≤ 30 °C/85% RH
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL-recognized component (E349212)





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#### FLUX CHARACTERISTICS (T, = 85 °C) - WHITE

The following table provides several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D Binning and Labeling document.

Color	CCT Range		Base Order Codes Min. Luminous Flux @ 350 mA			Calculated Minimum Luminous Flux (lm)*		Order Code	
	Min.		Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1000 mA		
			R2	114	130	199	252	XBDAWT-00-0000-000000E51	
Cool White	5000 K	8300 K	R3	122	139	213	270	XBDAWT-00-0000-000000F51	
			R4	130	148	227	287	XBDAWT-00-0000-000000G51	
			R2	114	130	199	252	XBDAWT-00-0000-00000BE51	
70 CRI Minimum Cool White	5000 K	8300 K	R3	122	139	213	270	XBDAWT-00-0000-00000BF51	
			R4	130	148	227	287	XBDAWT-00-0000-00000BG51	
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE4	
Neutral White	3700 K	5000 K	Q5	107	122	187	236	XBDAWT-00-0000-00000LDE4	
			R2	114	130	199	252	XBDAWT-00-0000-00000LEE4	
			Q2	87.4	100	153	193	XBDAWT-00-0000-00000HAE7	
80 CRI Minimum White	2600 K	4300 K	Q3	93.9	107	164	207	XBDAWT-00-0000-00000HBE7	
			Q4	100	114	172	222	XBDAWT-00-0000-00000HCE7	
		K 3700 K	Q2	87.4	100	153	193	XBDAWT-00-0000-00000LAE7	
Warm White	2600 K		Q3	93.9	107	164	207	XBDAWT-00-0000-00000LBE7	
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE7	

#### Notes:

- Cree maintains a tolerance of  $\pm 7\%$  on flux and power measurements,  $\pm 0.005$  on chromaticity (CCx, CCy) measurements and  $\pm 2$  on CRI measurements.
- Typical CRI for Neutral White, 3700 K 5000K CCT is 75.
- Typical CRI for Warm White, 2600 K 3700 K CCT is 80.
- Minimum CRI for 70 CRI Minimum Cool White is 70.
- Minimum CRI for 80 CRI Minimum White is 80.
- \* Flux values @ 25 °C are calculated and are for reference only.
- \* Calculated flux values are for reference only.



# FLUX CHARACTERISTICS ( $T_1 = 25$ °C) - COLOR

The following table provides several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D Binning and Labeling document.

	Domi	nant Wav	elength F	Range Base Order Codes Min. Radiant Flux								
Color	Min.		Max.		(mW) @ 350 mA		Order Code					
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (mW)							
										30 (J)	450	XBDROY-00-0000-000000K01
Royal Blue		D57	465	31 (K)	475	XBDROY-00-0000-000000P01						
				32 (L)	500	XBDROY-00-0000-000000Q01						

	Dominant Wavelength Range					rder Codes		
Color	Min.		Min. Max.		Min. Luminous Flux (lm) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)			
					J0	23.5	XBDBLU-00-0000-000000X01	
Pluo	Blue B3 465	B6	405	K2	30.6	XBDBLU-00-0000-000000Y01		
blue		33 403	ВО	485	K3	35.2	XBDBLU-00-0000-000000Z01	
					M2	39.8	XBDBLU-00-0000-000000201	

	Dominant Wavelength Range				rder Codes		
Color	Min.		Max.		Min. Luminous Flux (lm) @ 350 mA		Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)		
	63 530 6		F2F	P4	80.6	XBDGRN-00-0000-000000901	
Green		G4		535	Q2	87.4	XBDGRN-00-0000-000000A01
Green G2	GZ	G2 520	G4		Q3	93.9	XBDGRN-00-0000-000000B01
					Q4	100	XBDGRN-00-0000-000000C01

	Domi	nant Wav	elength F	Range		rder Codes		
Color	Min.		Min. Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)		
	A2 F0F A2		595	M3	45.7	XBDAMB-00-0000-00000301		
Amber		4.2		N2	51.7	XBDAMB-00-0000-000000401		
Amber A2	AZ	A2 585	585 A3	293	N3	56.8	XBDAMB-00-0000-000000501	
					N4	62.0	XBDAMB-00-0000-000000601	



	Domi	nant Wav	elength F	Range		rder Codes				
Color	Min.		Max.		Min. Luminous Flux (lm) @ 350 mA		Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)					
	J- 02 640 0			P2	67.2	XBDRDO-00-0000-000000701				
Red-		04	04	04	04	620	620	4 620	Р3	73.9
Orange 03	03 610		620	P4	80.6	XBDRDO-00-0000-00000901				
					Q2	87.4	XBDRDO-00-0000-000000A01			

	Dominant Wavelength Range				rder Codes				
Color	Min.		Max.		Min. Luminous Flux (lm) @ 350 mA		Order Code		
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)				
		22 620 82			N3	56.8	XBDRED-00-0000-000000501		
Red	R2		R3	630	620	630	630	N4	62.0
Reu	Reu RZ	620	K3		P2	67.2	XBDRED-00-0000-000000701		
					Р3	73.9	XBDRED-00-0000-00000801		

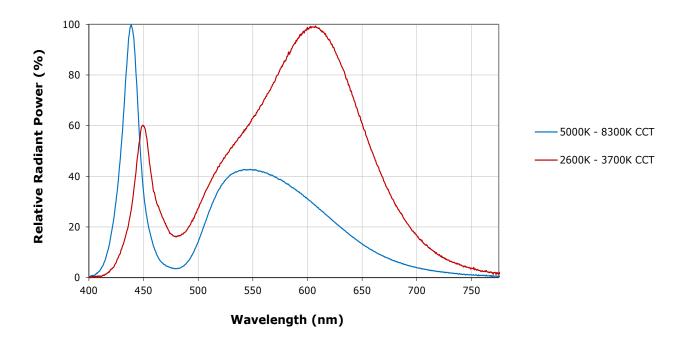
Note: Cree maintains a tolerance of +/-7% on flux and power measurements.

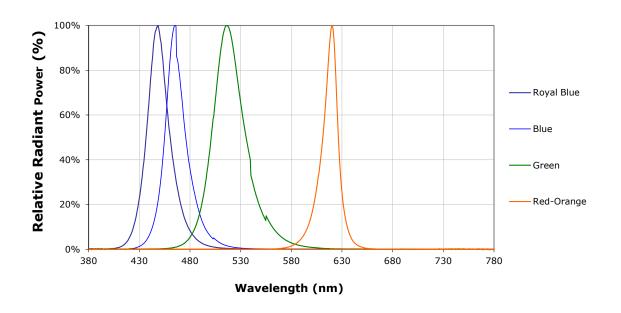
#### **CHARACTERISTICS**

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white	°C/W		6.5	
Thermal resistance, junction to solder point - royal blue, blue, red-orange	°C/W		6.5	
Thermal resistance, junction to solder point - green	°C/W		11	
Viewing angle (FWHM) - white	degrees		115	
Viewing angle (FWHM) - royal blue, blue, green	degrees		135	
Viewing angle (FWHM) - red-orange, red	degrees		145	
Temperature coefficient of voltage - white	mV/°C		-2.5	
Temperature coefficient of voltage - blue, green	mV/°C		-3.5	
Temperature coefficient of voltage - red-orange	mV/°C		-1.8	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			1000
Reverse voltage	V			-5
Forward voltage (@ 350 mA, 85 °C) - white	V		2.9	3.5
Forward voltage (@ 350 mA, 25 °C) - royal blue, blue	V		3.1	3.7
Forward voltage (@ 350 mA, 25 °C) - green	V		3.2	3.8
Forward voltage (@ 350 mA, 25 °C) - red-orange, red	V		2.1	2.6
LED junction temperature	°C			150



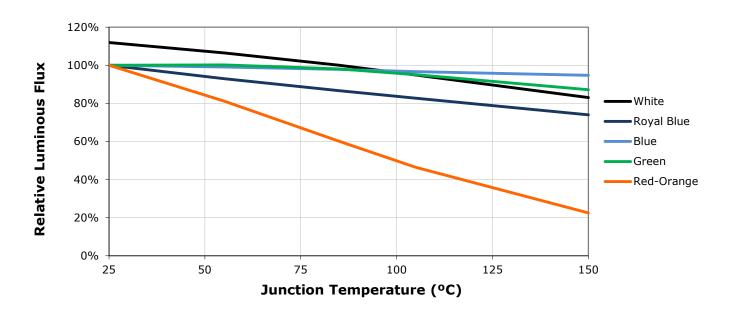
#### **RELATIVE SPECTRAL POWER DISTRIBUTION**



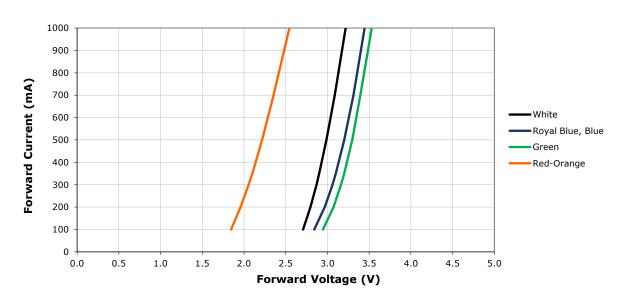




# RELATIVE FLUX VS. JUNCTION TEMPERATURE ( $I_F = 350 \text{ mA}$ )



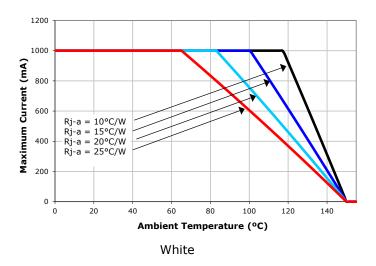
# **ELECTRICAL CHARACTERISTICS (T<sub>j</sub> = 85 °C)**

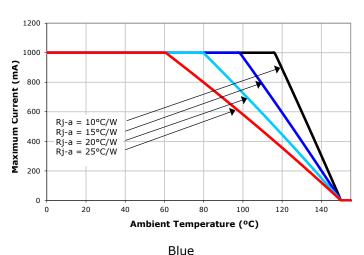


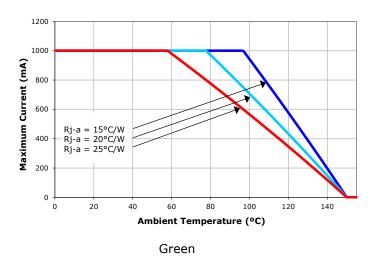


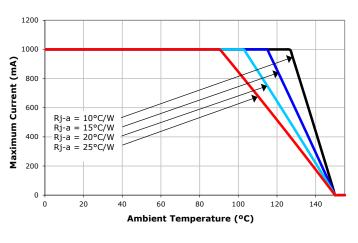
#### THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optomize lamp life and optical characteristics.



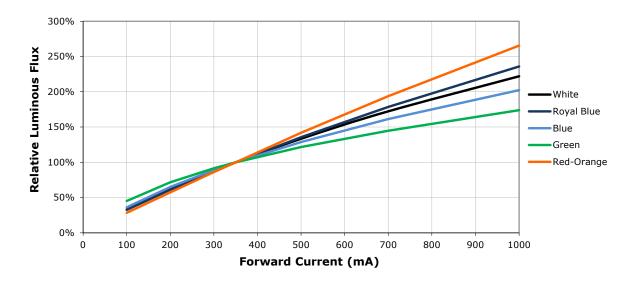






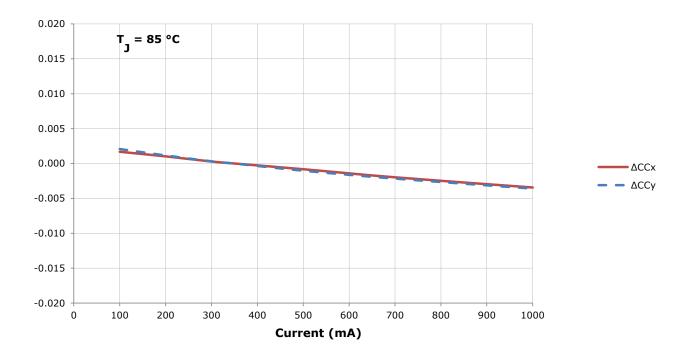


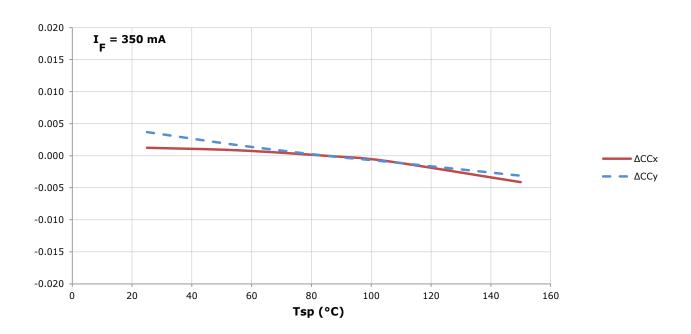
# RELATIVE FLUX VS. CURRENT ( $T_{j} = 85 \text{ °C}$ )





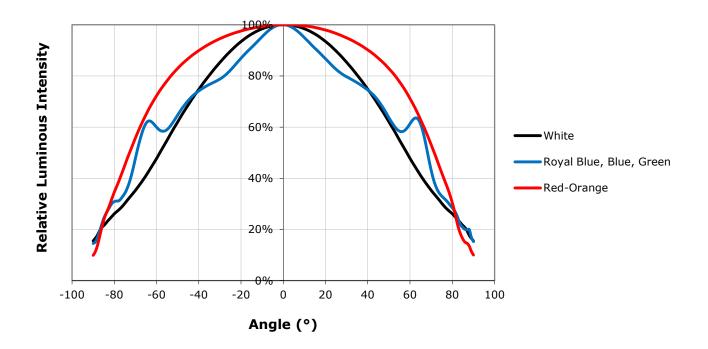
#### RELATIVE CHROMATICITY VS. CURRENT AND TEMPEATURE (WARM WHITE)







#### TYPICAL SPATIAL DISTRIBUTION

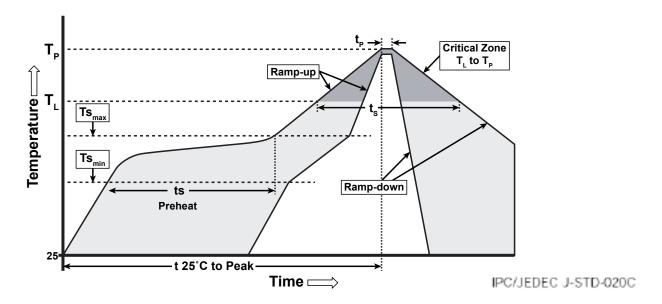




#### **REFLOW SOLDERING CHARACTERISTICS**

In testing, Cree has found XLamp XB-D LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts <sub>max</sub> to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts <sub>min</sub> )	100 °C	150 °C
Preheat: Temperature Max (Ts <sub>max</sub> )	150 °C	200 °C
Preheat: Time (ts <sub>min</sub> to ts <sub>max</sub> )	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T <sub>L</sub> )	183 °C	217 °C
Time Maintained Above: Time (t <sub>L</sub> )	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



#### **NOTES**

#### Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document at www.cree.com/xlamp\_app\_notes/LM80\_results.

Please read the XLamp Long-Term Lumen Maintenance application note at www.cree.com/xlamp\_app\_notes/XRE\_lumen\_maintenance for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note at www.cree.com/xlamp\_app\_notes/thermal\_management for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

#### Moisture Sensitivity

In testing, Cree has found XLamp XB-D LEDs to have unlimited floor life in conditions ≤30 °C/85% relative humidity (RH). Moisture testing included a 168-hour soak at 85 °C/85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDs to the resealable moisture-barrier bag and closing the bag immediately after use.

#### RoHS Compliance

The levels of environmentally sensitive, persistent biologically toxic (PBT), persistent organic pollutants (POP), or otherwise restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), as amended through April 21, 2006.

#### **UL Recognized Component**

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

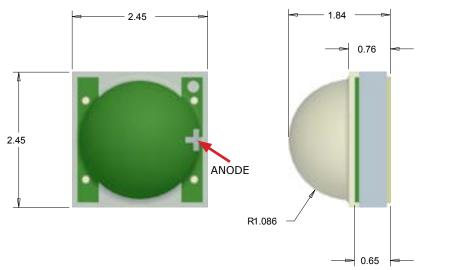
#### Vision Advisory Claim

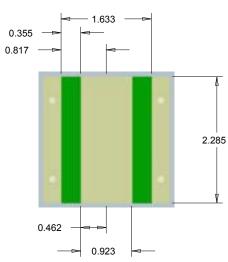
WARNING: Do not look at exposed lamp in operation. Eye injury can result. See the LED Eye Safety application note at www.cree.com/xlamp\_app\_notes/led\_eye\_safety.

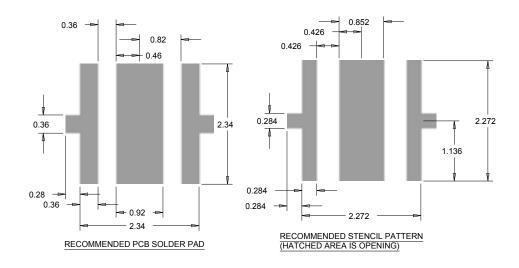


#### **MECHANICAL DIMENSIONS**

All measurements are  $\pm .13$  mm unless otherwise indicated.





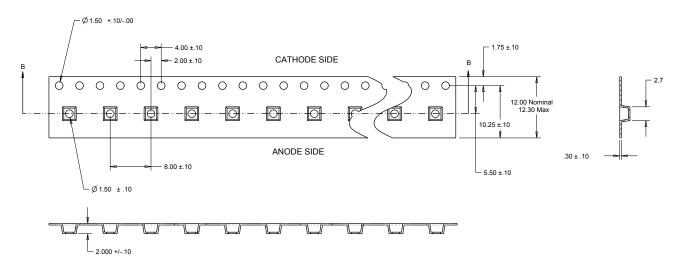


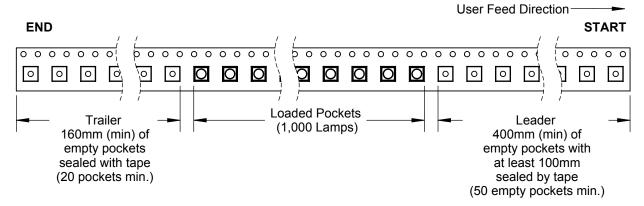


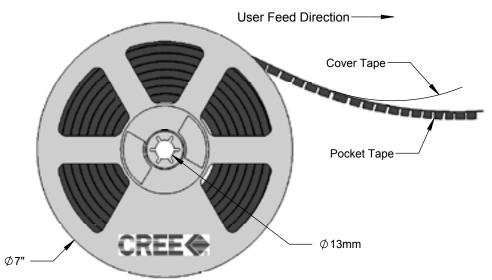
#### **TAPE AND REEL - XB-D LEDS**

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

#### All dimensions in mm









#### **PACKAGING**

# **Unpackaged Reel** Label with Cree Bin Code, Qty, Reel ID

**Packaged Reel** 

